



$V_{(BR)DSS}$	$R_{DS(ON)Typ}$	$I_D Max$
60V	1.9Ω @ 10V	0.3A
	2.1Ω @ 4.5V	

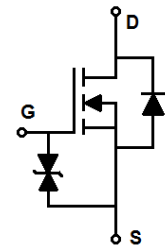
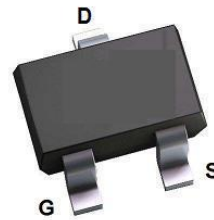
Features

- Low $R_{DS(on)}$ @ $V_{GS}=10V$
- 5V Logic Level Control
- N Channel SOT323 Package
- ESD Protection
- Pb-Free, RoHS Compliant

Applications

- Logic level translators
- High-speed line drivers
- Low-side load switch
- Switching circuits
- Relay driv

SOT323



Absolute Maximum Ratings

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
Common Ratings (TA=25°C Unless Otherwise Noted)			
V_{GS}	Gate-Source Voltage	±20	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	60	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 150	°C
Mounted on Large Heat Sink			
I_{DM}	Pulse Drain Current Tested①	$T_A=25^\circ C$	1.2 A
I_D	Continuous Drain Current($V_{GS}=4.5V$)	$T_A=25^\circ C$	0.3 A
		$T_A=70^\circ C$	0.24 A
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	0.3 W
		$T_A=70^\circ C$	0.2 W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	400	°C/W



Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current(T _A =25°C)	V _{DS} =60V, V _{GS} =0V	-	-	1	μA
	Zero Gate Voltage Drain Current(T _A =125°C)	V _{DS} =48V, V _{GS} =0V	-	-	100	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±10	uA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.9	2.5	V
R _{DS(ON)}	Drain-Source On-State Resistance②	V _{GS} =10V, I _D =0.3A	-	1.9	3	Ω
R _{DS(ON)}	Drain-Source On-State Resistance②	V _{GS} =4.5V, I _D =0.3A	-	2.1	4	Ω
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =30V, V _{GS} =0V, f=1MHz	-	16	-	pF
C _{oss}	Output Capacitance		-	3.8	-	pF
C _{rss}	Reverse Transfer Capacitance		-	0.6	-	pF
Q _g	Total Gate Charge	V _{DS} =30V I _D =0.5A, V _{GS} =10V	-	0.72	-	nC
Q _{gs}	Gate Source Charge		-	0.15	-	nC
Q _{gd}	Gate Drain Charge		-	0.22	-	nC
Switching Characteristics						
t _{d(on)}	Turn on Delay Time	V _{DD} =30V, I _D =0.3A, R _G =3.3Ω, V _{GS} =10V	-	5	-	ns
t _r	Turn on Rise Time		-	3.3	-	ns
t _{d(off)}	Turn Off Delay Time		-	18	-	ns
t _f	Turn Off Fall Time		-	5.2	-	ns
Source Drain Diode Characteristics						
I _{SD}	Source drain current(Body Diode)	T _A =25°C	-	-	0.5	A
V _{SD}	Forward on voltage②	T _J =25°C, I _{SD} =0.5A, V _{GS} =0V	-	0.73	1.2	V

Notes:

① Pulse width limited by maximum allowable junction temperature

② Pulse test ; Pulse width≤300μs, duty cycle≤2%.



Typical Characteristics

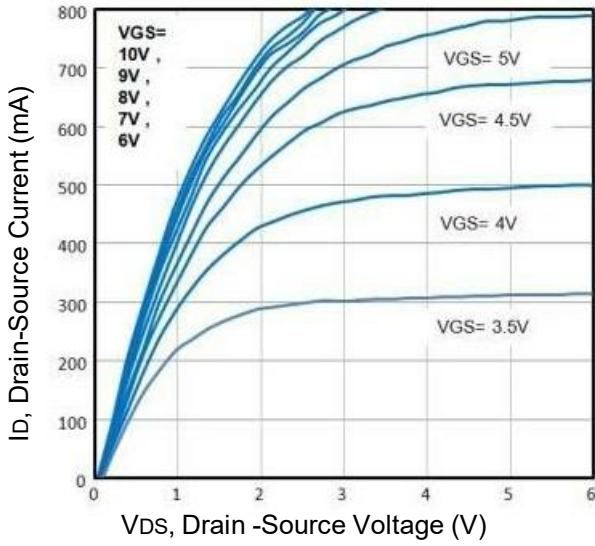


Fig1. Typical Output Characteristics

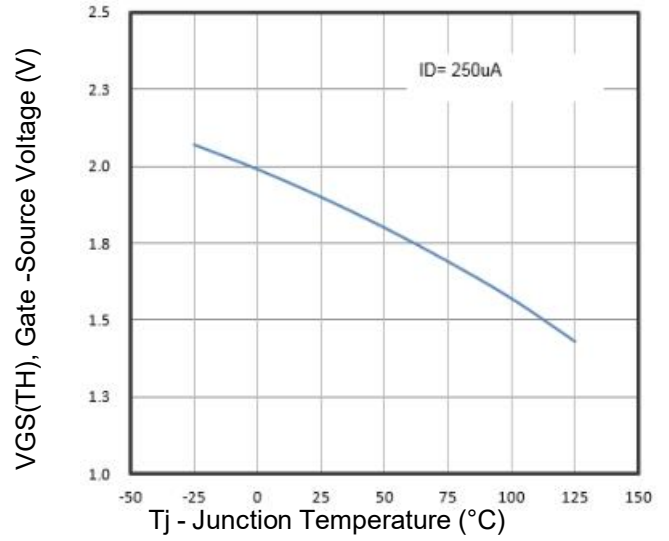


Fig2. Normalized Threshold Voltage Vs. Temperature

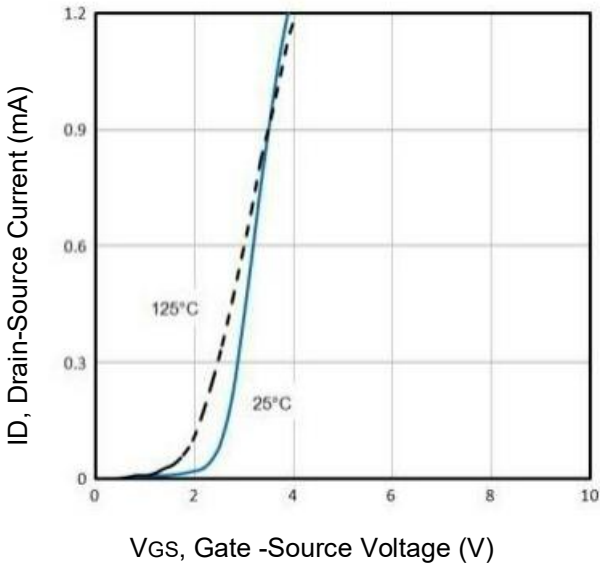


Fig3. Typical Transfer Characteristics

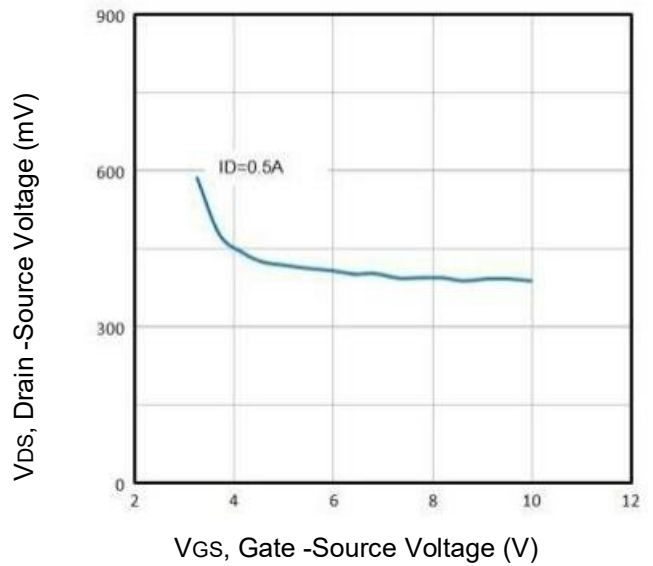


Fig4. Drain-Source Voltage vs Gate-Source Voltage

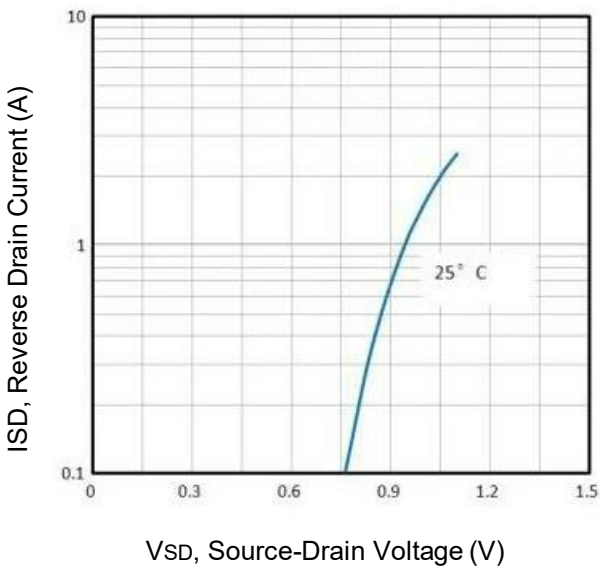


Fig5. Typical Source-Drain Diode Forward Voltage

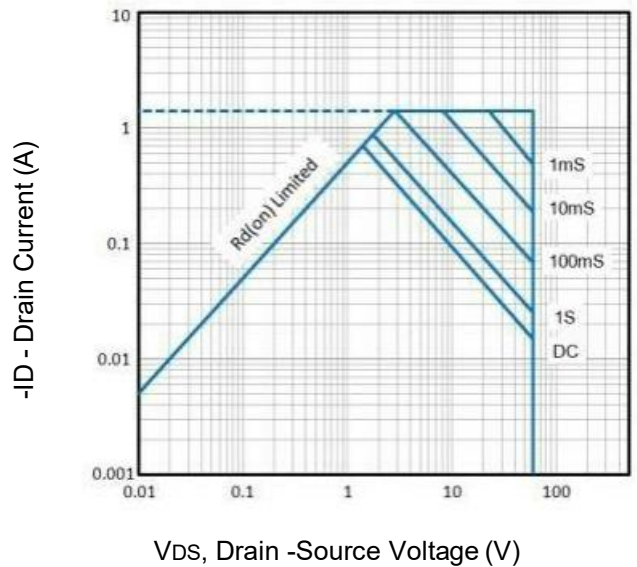


Fig6. Maximum Safe Operating Area



Typical Characteristics

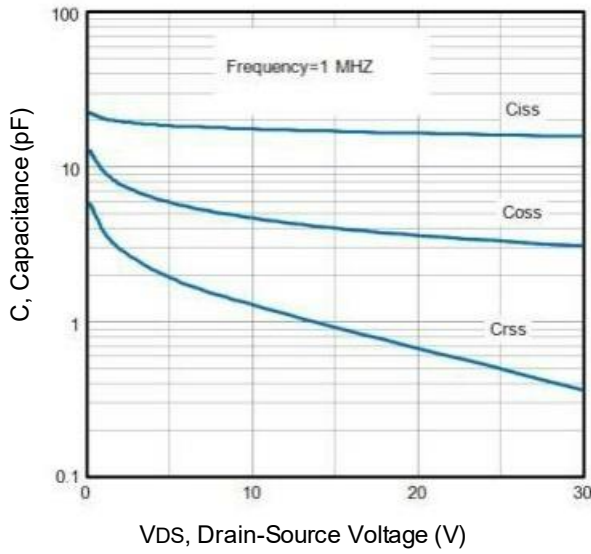


Fig7. Typical Capacitance Vs. Drain-Source Voltage

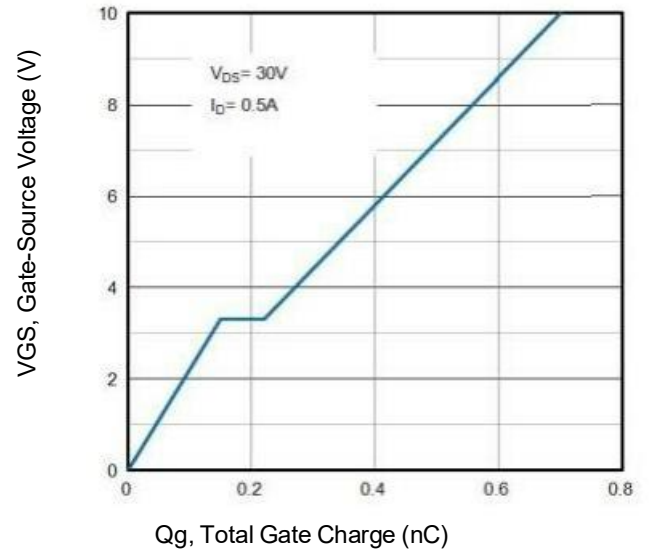


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

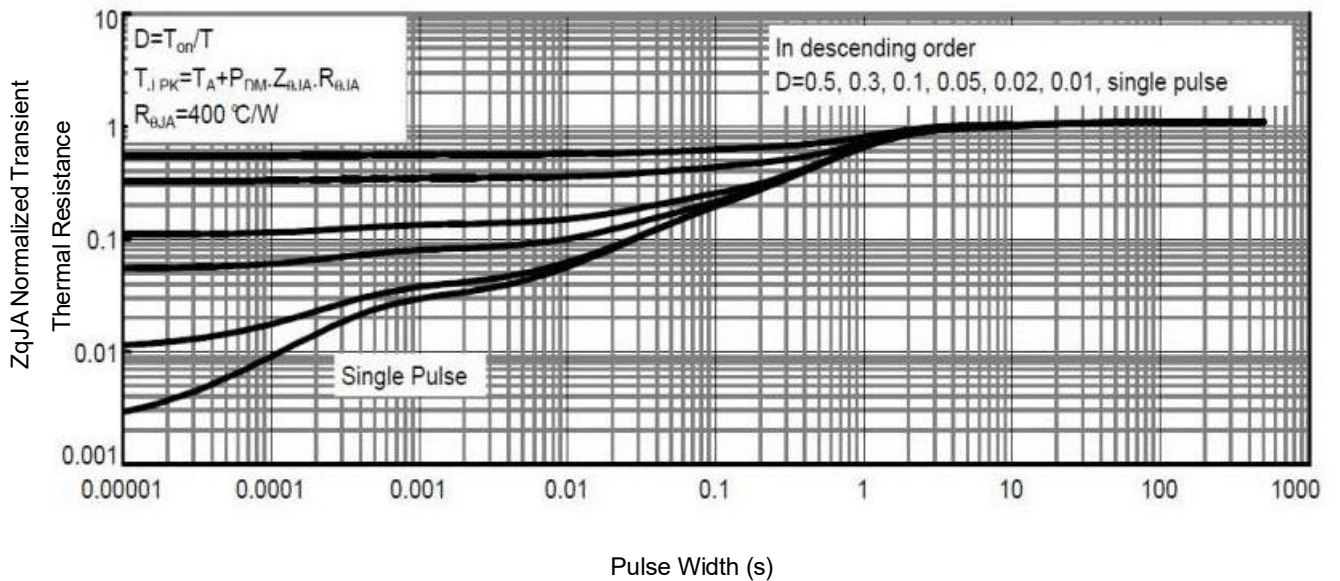


Fig9. Normalized Maximum Transient Thermal Impedance

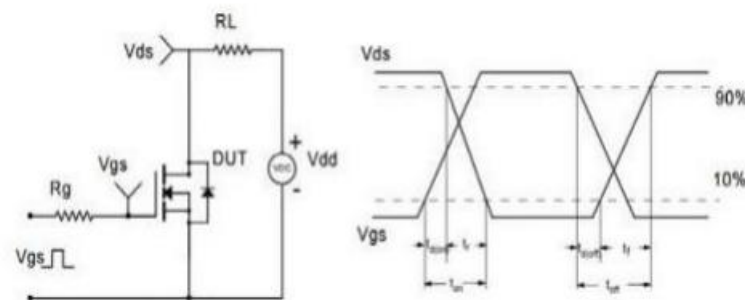
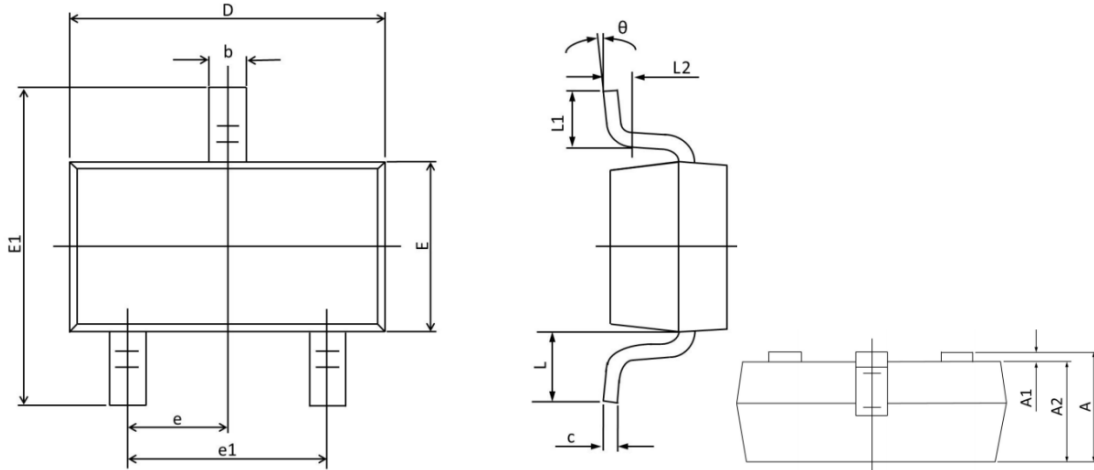


Fig10. Switching Time Test Circuit and waveforms



SOT-323 Mechanical Data



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
A1	0.100	0.000	0.004	0.000
A2	1.000	0.800	0.039	0.031
b	0.400	0.200	0.016	0.008
c	0.250	0.080	0.010	0.003
D	2.200	1.800	0.087	0.071
E	1.350	1.150	0.053	0.045
E1	2.450	1.800	0.096	0.071
e	0.65BSC		0.026BSC	
e1	1.400	1.200	0.055	0.047
L	0.525REF.		0.021REF.	
L1	0.460	0.150	0.018	0.006
L2	0.200	0.000	0.008	0.000
θ	8°	0°	8°	0°

Ordering Information

Part No.	Marking	Package	Shipping Quantity
2N7002KW	7002	SOT-323	3000PCS/Reel

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